

Base / Seed Coat 2-Component Epoxy







Low Odor & Low VOC's



- Fast Curing
 - Remove excess flake within 2 to 3 hours
 - Recoat once excess flake is reclaimed
 - May be used One Day Installation System
- Intended for residential Vinyl Chip floors
- Soap & Water Tool Clean-up while wet



Step 1: Preparation

Step 2: Color Base / Broadcast

Step 3: Seal Coat

Step 4: Topcoat









Mechanically prepare concrete substrates to a CSP 2 – 3 via diamond grinding or shotblasting









Mix Smith's Epoxy VCB³⁸ with addition of Smith's WSC Color Packs, pour out a ribbon, spread with 8 mil notched squeegee @ 200 sq.ft. per gallon then back roll with 3/8" nap non-shed roller. Immediately broadcast vinyl chip to rejection. Allow 2 to 3 hour cure.









Once hard set, sweep off excess Vinyl Chip then thoroughly vacuum. Spray or pour a ribbon of Smith's Poly-SEAL then backroll at 200 sq.ft. per gallon. Allow to dry clear & tack free before topcoat









Mix Smith's Poly-WB then pour into a wide mouth paint tray, dip & roll apply using a 3/8" non-shed premium roller cover to V roll at a rate of 200 sq.ft. per gallon

